

**EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -**  
**Wholesale and Retail.**

**Phase Control Disc Thyristor Type DT56-1600-8**

High power cycling capability / Low on-state and switching losses  
 Designed for traction and industrial applications

Mean on-state current	I <sub>TAV</sub>	1600 A						
Repetitive peak off-state voltage	V <sub>DRM</sub>	100 ÷ 800 V						
Repetitive peak reverse voltage	V <sub>RRM</sub>							
Turn-off time	t <sub>q</sub>	160, 200, 250, 320, 400, 500 µs						
V <sub>DRM</sub> , V <sub>RRM</sub> , V	100	200	300	400	500	600	700	800
Voltage code	1	2	3	4	5	6	7	8
T <sub>j</sub> , °C				-60 ÷ 140				

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
I <sub>TAV</sub>	Mean on-state current	A	1600 2106	T <sub>c</sub> =102 °C, Double side cooled T <sub>c</sub> =85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TRMS</sub>	RMS on-state current	A	2512	T <sub>c</sub> =102 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TSM</sub>	Surge on-state current	kA	39.0 45.0	T <sub>j</sub> =T <sub>j</sub> <sub>max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
			41.0 47.0	T <sub>j</sub> =T <sub>j</sub> <sub>max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
I <sup>2</sup> t	Safety factor	A <sup>2</sup> s·10 <sup>3</sup>	7600 10100	T <sub>j</sub> =T <sub>j</sub> <sub>max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
			6900 9100	T <sub>j</sub> =T <sub>j</sub> <sub>max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs
<b>BLOCKING</b>					
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse voltages	V	100÷800	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; 50 Hz; Gate open	
V <sub>DSM</sub> , V <sub>RSM</sub>	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	200÷900	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; single pulse; Gate open	
V <sub>D</sub> , V <sub>R</sub>	Direct off-state and Direct reverse voltages	V	0.6·V <sub>DRM</sub> 0.6·V <sub>RRM</sub>	T <sub>j</sub> =T <sub>j</sub> <sub>max</sub> ; Gate open	

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### TRIGGERING

$I_{FGM}$	Peak forward gate current	A	8	$T_j = T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	

### SWITCHING

$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu$ s	1000	$T_j = T_{j\max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 3200$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
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### THERMAL

$T_{stg}$	Storage temperature	°C	-60÷50	
$T_j$	Operating junction temperature	°C	-60÷140	

### MECHANICAL

F	Mounting force	kN	24.0÷28.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
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### ON-STATE

$V_{TM}$	Peak on-state voltage, max	V	1.50	$T_j = 25$ °C; $I_{TM} = 5024$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.857	$T_j = T_{j\max};$
$r_T$	On-state slope resistance, max	$m\Omega$	0.115	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
$I_L$	Latching current, max	mA	1500	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I_H$	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open

### BLOCKING

$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\max};$ $V_D = V_{DRM}; V_R = V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open

### TRIGGERING

$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	$T_j = T_{j\min}$ $T_j = 25$ °C $T_j = T_{j\max}$
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.50	$T_j = T_{j\max};$
$I_{GD}$	Gate non-trigger direct current, min	mA	55.00	$V_D = 0.67 \cdot V_{DRM};$ Direct gate current

### SWITCHING

$t_{gd}$	Delay time, max	$\mu$ s	0.85	$T_j = 25$ °C; $V_D = 600$ V; $I_{TM} = I_{TAV};$ $di/dt = 200$ A/ $\mu$ s;
$t_{gt}$	Turn-on time, max	$\mu$ s	5.00	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ $\mu$ s
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	160, 200, 250, 320, 400, 500	$dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}; I_{TM} = I_{TAV};$ $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$
$Q_{rr}$	Total recovered charge, max	$\mu$ C	1250	$T_j = T_{j\max}; I_{TM} = I_{TAV};$
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	18	$di_R/dt = -10$ A/ $\mu$ s;
$I_{rrM}$	Peak reverse recovery current, max	A	140	$V_R = 100$ V;

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THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0180	Direct current	Double side cooled
$R_{thjc-A}$			0.0396		Anode side cooled
$R_{thjc-K}$			0.0324		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0040	Direct current	

MECHANICAL					
w	Weight, max	g	330		
$D_s$	Surface creepage distance	mm (inch)	7.51 (0.295)		
$D_a$	Air strike distance	mm (inch)	5.60 (0.220)		

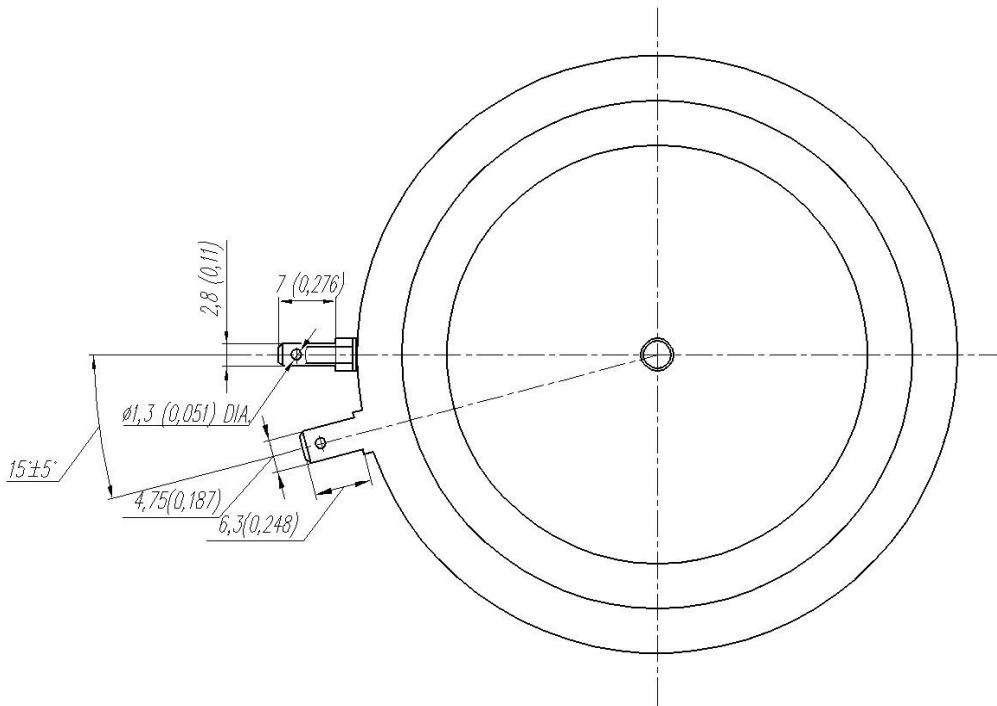
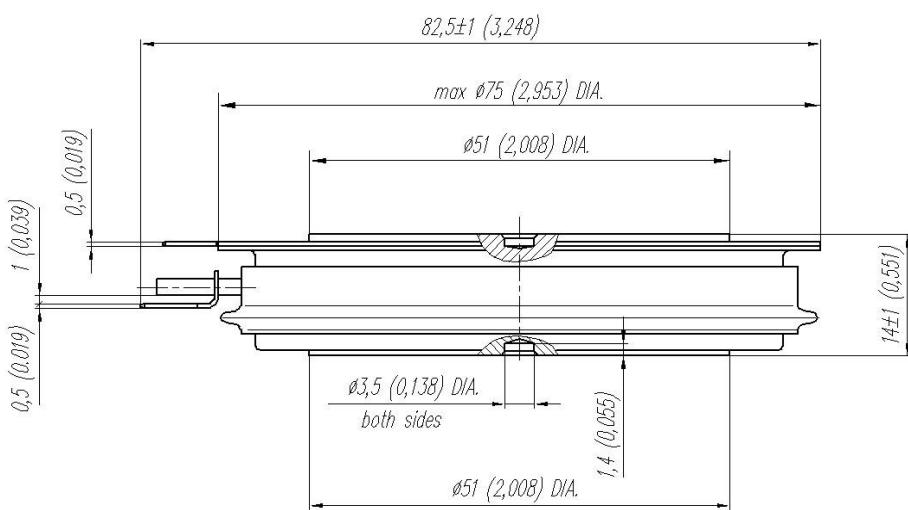
PART NUMBERING GUIDE						NOTES							
DT	56	1600	8	7	3	1) Critical rate of rise of off-state voltage							
1	2	3	4	5	6	Symbol of Group	4	5	6	7	8	8.5	9
1. DT - Phase Control Disc Thyristor						$(dv_D/dt)_{crit}, \text{V}/\mu\text{s}$	200	320	500	1000	1600	2000	2500
2. Element Diameter						2) Turn-off time ( $dv_D/dt=50 \text{ V}/\mu\text{s}$ )							
3. Mean on-state current, A						Symbol of Group	3	0	0	0	0	0	
4. Voltage code						$t_{off}, \mu\text{s}$	160	200	250	320	400	500	
5. Critical rate of rise of on-state current non-repetitive, $\text{V}/\mu\text{s}$													
6. Turn-off time ( $dv_D/dt=50 \text{ V}/\mu\text{s}$ )													

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### **OVERALL DIMENSIONS**

**Package type: T.D1**



All dimensions in millimeters (inches)